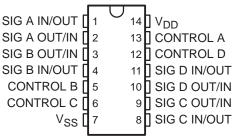
- 15-V Digital or ±7.5-V Peak-to-Peak **Switching**
- 125-Ω Typical On-State Resistance for 15-V Operation
- Switch On-State Resistance Matched to Within 5  $\Omega$  Over 15-V Signal-Input Range
- **On-State Resistance Flat Over Full** Peak-to-Peak Signal Range
- High On/Off Output-Voltage Ratio: 80 dB Typical at  $f_{is} = 10 \text{ kHz}$ ,  $R_L = 1 \text{ k}\Omega$
- **High Degree of Linearity: <0.5% Distortion** Typical at  $f_{is} = 1 \text{ kHz}$ ,  $V_{is} = 5 \text{ V p-p}$ ,  $V_{DD} - V_{SS} \ge 10 \text{ V}, R_L = 10 \text{ k}\Omega$
- Extremely Low Off-State Switch Leakage, Resulting in Very Low Offset Current and High Effective Off-State Resistance: 10 pA Typical at  $V_{DD} - V_{SS} = 10 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$
- **Extremely High Control Input Impedance** (Control Circuit Isolated From Signal Circuit):  $10^{12} \Omega$  Typical
- Low Crosstalk Between Switches: -50 dB Typical at  $f_{is} = 8 \text{ MHz}$ ,  $R_L = 1 \text{ k}\Omega$

- **Matched Control-Input to Signal-Output** Capacitance: Reduces Output Signal **Transients**
- Frequency Response, Switch On = 40 MHz **Typical**
- 100% Tested for Quiescent Current at 20 V
- 5-V, 10-V, and 15-V Parametric Ratings
- Meets All Requirements of JEDEC Tentative Standard No. 13-B, Standard Specifications for Description of "B" Series CMOS Devices
- **Applications:** 
  - Analog Signal Switching/Multiplexing: Signal Gating, Modulator, Squelch Control, Demodulator, Chopper, **Commutating Switch**
  - Digital Signal Switching/Multiplexing
  - Transmission-Gate Logic Implementation
  - Analog-to-Digital and Digital-to-Analog Conversion
  - Digital Control of Frequency, Impedance, Phase, and Analog-Signal Gain

### E, F, M, NS, OR PW PACKAGE (TOP VIEW)



#### description/ordering information

The CD4066B is a quad bilateral switch intended for the transmission or multiplexing of analog or digital signals. It is pin-for-pin compatible with the CD4016B, but exhibits a much lower on-state resistance. In addition, the on-state resistance is relatively constant over the full signal-input range.

The CD4066B consists of four bilateral switches, each with independent controls. Both the p and the n devices in a given switch are biased on or off simultaneously by the control signal. As shown in Figure 1, the well of the n-channel device on each switch is tied to either the input (when the switch is on) or to VSS (when the switch is off). This configuration eliminates the variation of the switch-transistor threshold voltage with input signal and, thus, keeps the on-state resistance low over the full operating-signal range.

The advantages over single-channel switches include peak input-signal voltage swings equal to the full supply voltage and more constant on-state impedance over the input-signal range. However, for sample-and-hold applications, the CD4016B is recommended.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

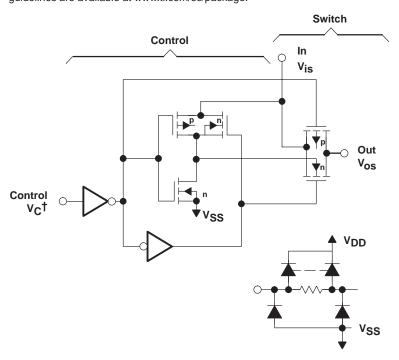


### description/ordering information (continued)

#### **ORDERING INFORMATION**

TA	PACK	AGE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	CDIP – F	Tube of 25	CD4066BF3A	CD4066BF3A	
	PDIP – E	Tube of 25	CD4066BE	CD4066BE	
	SOIC - M	Tube of 50	CD4066BM		
_55°C to 125°C		Reel of 2500	CD4066BM96	CD4066BM	
-55 C to 125 C		Reel of 250	CD4066BMT		
	SOP – NS	Reel of 2000	CD4066BNSR	CD4066B	
	TSSOP – PW	Tube of 90	CD4066BPW	CM066B	
	13307 - PW	Reel of 2000	CD4066BPWR	CIVIUOOB	

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



<sup>†</sup> All control inputs are protected by the CMOS protection network.

NOTES: A. All p substrates are connected to  $V_{\mbox{\scriptsize DD}}$ .

- B. Normal operation control-line biasing: switch on (logic 1),  $V_C = V_{DD}$ ; switch off (logic 0),  $V_C = V_{SS}$
- C. Signal-level range:  $V_{SS} \le V_{is} \le V_{DD}$

92CS-29113

Figure 1. Schematic Diagram of One-of-Four Identical Switches and Associated Control Circuitry



SCHS051D - NOVEMBER 1998 - REVISED SEPTEMBER 2003

### 

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions

		MIN	MAX	UNIT
$V_{DD}$	Supply voltage	3	18	V
TA	Operating free-air temperature	-55	125	°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### electrical characteristics

					LIMITS AT INDICATED TEMPERATURES						
	PARAMETER	TEST CONDITIONS	VIN	$v_{DD}$				125°C	25	°C	UNIT
			(V)	(V)	–55°C	–40°C	85°C		TYP	MAX	
			0, 5	5	0.25	0.25	7.5	7.5	0.01	0.25	
1	Quiescent device		0, 10	10	0.5	0.5	15	15	0.01	0.5	
IDD	current		0, 15	15	1	1	30	30	0.01	1	μΑ
			0, 20	20	5	5	150	150	0.02	5	
Signal	Inputs (Vis) and Outpu	ıts (V <sub>OS</sub> )							_		
		$V_C = V_{DD}$ , $R_L = 10 \text{ k}\Omega \text{ returned}$		5	800	850	1200	1300	470	1050	
r <sub>on</sub>	On-state resistance (max)	to $\frac{(V_{DD} - V_{SS})}{2}$ ,		10	310	330	500	550	180	400	Ω
		$V_{iS} = V_{SS}$ to $V_{DD}$		15	200	210	300	320	125	240	
	On-state resistance			5					15		
$\Delta r_{\mbox{on}}$	difference between	$R_L = 10 \text{ k}\Omega, V_C = V_{DD}$		10					10		Ω
	any two switches			15					5		
THD	Total harmonic distortion	$V_C = V_{DD} = 5 \text{ V}, V_{SS} = -5$ $V_{is(p-p)} = 5 \text{ V} \text{ (sine wave ce}$ $R_L = 10 \text{ k}\Omega, f_{iS} = 1 \text{-kHz sine}$	entered o	n 0 V),					0.4		%
	-3-dB cutoff frequency (switch on)	$V_C = V_{DD} = 5 \text{ V}, V_{SS} = -5 \text{ V}$ (sine wave centered on 0 V	/, V <sub>is(p-p</sub> /), R <sub>L</sub> = 1	) = 5 V kΩ					40		MHz
	-50-dB feedthrough frequency (switch off)	$V_C = V_{SS} = -5 \text{ V}, V_{is(p-p)} = 0$ (sine wave centered on 0 V	= 5 V '), R <sub>L</sub> = 1	kΩ					1		MHz
I <sub>iS</sub>	Input/output leakage current (switch off) (max)	$V_C = 0 \text{ V}, V_{is} = 18 \text{ V}, V_{os} = $ and $V_C = 0 \text{ V}, V_{is} = 0 \text{ V}, V_{os} = 1 $		18	±0.1	±0.1	±1	±1	±10 <sup>-5</sup>	±0.1	μΑ
	–50-dB crosstalk frequency	$V_{C}(A) = V_{DD} = 5 \text{ V},$ $V_{C}(B) = V_{SS} = -5 \text{ V},$ $V_{is}(A) = 5 V_{p-p}, 50-\Omega \text{ sourc}$ $R_{L} = 1 \text{ k}\Omega$	ce,						8		MHz
	Propagation delay	$R_L = 200 \text{ k}\Omega, V_C = V_{DD},$ $V_{SS} = GND, C_L = 50 \text{ pF},$		5					20	40	ns
<sup>t</sup> pd	(signal input to signal output)	V <sub>is</sub> = 10 V (square wave centered on 5	5 V).	10					10	20	
	<u> </u>	$t_r$ , $t_f = 20 \text{ ns}$	/;	15					7	15	
Cis	Input capacitance	$V_{DD} = 5 \text{ V}, V_{C} = V_{SS} = -5$	V						8		pF
Cos	Output capacitance	$V_{DD} = 5 \text{ V}, V_{C} = V_{SS} = -5$	V						8		pF
Cios	Feedthrough	$V_{DD} = 5 \text{ V}, V_{C} = V_{SS} = -5$	V						0.5		pF



### electrical characteristics (continued)

				LIN	IITS AT II	NDICATE	D TEMPE	RATURE	S	
0	CHARACTERISTIC	TEST CONDITIONS V		F500	4000	2500	125°C	25°C		UNIT
			(V)	–55°C	–40°C	85°C	125-0	TYP	MAX	
Contro	ol (VC)									
	Controlingut	I <sub>is</sub>   < 10 μA,	5	1	1	1	1		1	
VILC	Control input, low voltage (max)	$V_{iS} = V_{SS}$ , $V_{OS} = V_{DD}$ , and	10	2	2	2	2		2	V
		$V_{iS} = V_{DD}, V_{OS} = V_{SS}$	15	2	2	2	2		2	
	Controlingut		5			3.5 (1	MIN)			
VIHC	Control input, high voltage	See Figure 6	10	7 (MIN)						V
			15	11 (MIN)						
I <sub>IN</sub>	Input current (max)	$V_{is} \le V_{DD}$ , $V_{DD} - V_{SS} = 18 \text{ V}$ , $V_{CC} \le V_{DD} - V_{SS}$	18	±0.1	±0.1	±1	±1	±10 <sup>-5</sup>	±0.1	μΑ
	Crosstalk (control input to signal output)	$V_C = 10 \text{ V (square wave)},$ $t_f$ , $t_f = 20 \text{ ns}$ , $R_L = 10 \text{ k}\Omega$	10					50		mV
			5					35	70	ns
	Turn-on and turn-off propagation delay	$V_{IN} = V_{DD}$ , $t_r$ , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 1$ k $\Omega$	10					20	40	
	propagation dolay		15					15	30	
		$\begin{aligned} & V_{\text{is}} = V_{DD}, \ V_{\text{SS}} = \text{GND}, \\ & R_{L} = 1 \ \text{k}\Omega \ \text{to GND}, \ C_{L} = 50 \ \text{pF}, \\ & V_{C} = 10 \ \text{V} \ (\text{square wave} \\ & \text{centered on 5 V)}, \ t_{\text{f}}, \ t_{\text{f}} = 20 \ \text{ns}, \\ & V_{\text{OS}} = 1/2 \ V_{\text{OS}} \ \text{at 1 kHz} \end{aligned}$	5					6		
	Maximum control input repetition rate		10					9		MHz
			15					9.5		
Cl	Input capacitance							5	7.5	pF

# switching characteristics

.,		SWITCH							
V <sub>DD</sub> (V)	V <sub>is</sub>		OUTPUT, V <sub>OS</sub> (V)						
	(V)	–55°C	-55°C -40°C 25°C 85°C 125°C						
5	0	0.64	0.61	0.51	0.42	0.36		0.4	
5	5	-0.64	-0.61	-0.51	-0.42	-0.36	4.6		
10	0	1.6	1.5	1.3	1.1	0.9		0.5	
10	10	-1.6	-1.5	-1.3	-1.1	-0.9	9.5		
15	0	4.2	4	3.4	2.8	2.4		1.5	
15	15	-4.2	-4	-3.4	-2.8	-2.4	13.5		

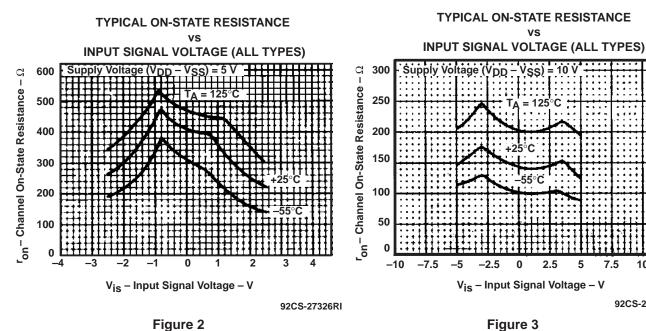


Figure 2

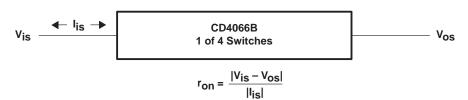
#### **TYPICAL ON-STATE RESISTANCE TYPICAL ON-STATE RESISTANCE INPUT SIGNAL VOLTAGE (ALL TYPES) INPUT SIGNAL VOLTAGE (ALL TYPES)** Supply Voltage $(V_{DD} - V_{SS}) = 15$ $m C_{on}$ – Channel On-State Resistance – $\Omega$ ${f r}_{ m on}-$ Channel On-State Resistance – $\Omega$ 300 600 500 250 200 400 300 150 100 200 100 50 -107.5 10 -7.5 2.5 7.5 10 Vis - Input Signal Voltage - V V<sub>is</sub> - Input Signal Voltage - V 92CS-27329RI 92CS-27330RI

Figure 4

Figure 5

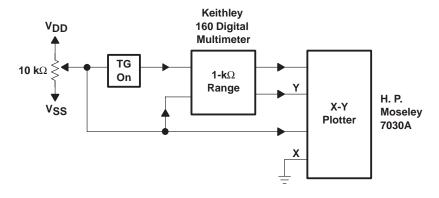
92CS-27327RI





92CS-30966

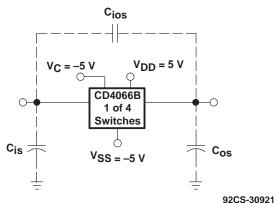
Figure 6. Determination of ron as a Test Condition for Control-Input High-Voltage (VIHC) Specification



92CS-22716

Figure 7. Channel On-State Resistance Measurement Circuit

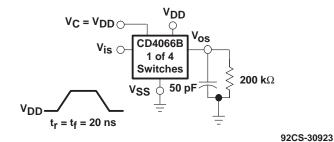
#### POWER DISSIPATION PER PACKAGE **TYPICAL ON CHARACTERISTICS** vs **FOR 1 OF 4 CHANNELS** SWITCHING FREQUENCY 104 AMBIENT TEMPERATURE (TA) = 25°C T<sub>A</sub> = 25°C VDD = 2.5 V, VSS = -2.5 V Power Dissipation Per Package $-\mu \text{W}$ 103 **Supply Voltage** $(V_{DD}) = 15 V$ V<sub>O</sub> - Output Voltage - V 1000 10 V 10<sup>2</sup> 14 V<sub>DD</sub> 0 $V_{DD}$ VC = VDDCD4066B 1 of 4 6 CD4066B 101 Switches ٧ss $^{P_{D^{-}}}$ All unused terminals are connected to VS 102 10 103 V<sub>I</sub> - Input Voltage - V f – Switching Frequency – kHz 92CS-30919 92C-30920 Figure 8 Figure 9



Measured on Boonton capacitance bridge, model 75a (1 MHz);

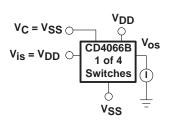
test-fixture capacitance nulled out.

Figure 10. Typical On Characteristics for One of Four Channels



All unused terminals are connected to VSS.

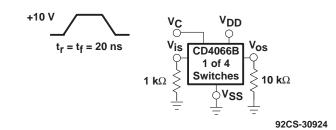
Figure 12. Propagation Delay Time Signal Input  $(V_{iS})$  to Signal Output  $(V_{oS})$ 



92CS-30922

All unused terminals are connected to VSS.

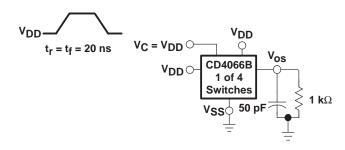
Figure 11. Off-Switch Input or Output Leakage



All unused terminals are connected to VSS.

Figure 13. Crosstalk-Control Input to Signal Output

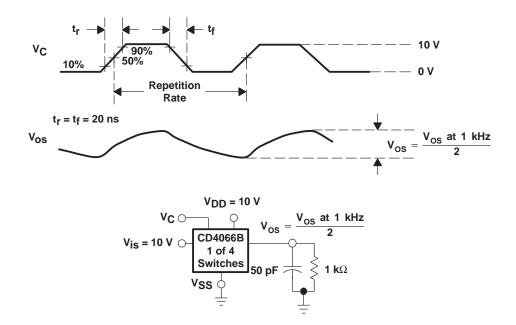




92CS-30925

NOTES: A. All unused terminals are connected to VSS. B. Delay is measured at  $V_{OS}$  level of +10% from ground (turn-on) or on-state output level (turn-off).

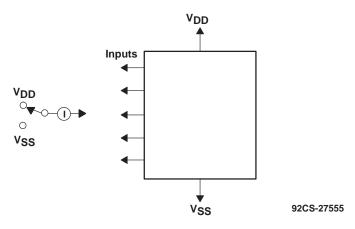
Figure 14. Propagation Delay, t<sub>PLH</sub>, t<sub>PHL</sub> Control-Signal Output



All unused terminals are connected to VSS.

92CS-30925

Figure 15. Maximum Allowable Control-Input Repetition Rate



Measure inputs sequentially to both VDD and VSS. Connect all unused inputs to either VDD or VSS. Measure control inputs only.

Figure 16. Input Leakage-Current Test Circuit

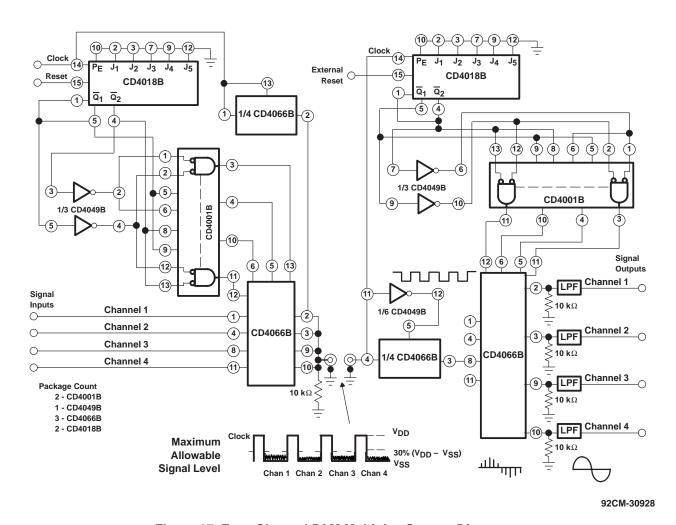
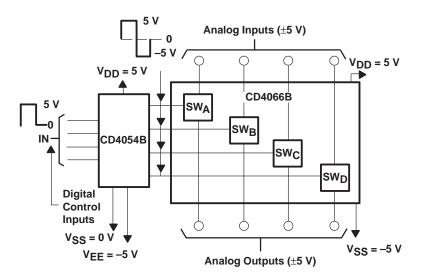


Figure 17. Four-Channel PAM Multiplex System Diagram





92CS-30927

Figure 18. Bidirectional Signal Transmission Via Digital Control Logic

SCHS051D - NOVEMBER 1998 - REVISED SEPTEMBER 2003

#### **APPLICATION INFORMATION**

In applications that employ separate power sources to drive  $V_{DD}$  and the signal inputs, the  $V_{DD}$  current capability should exceed  $V_{DD}/R_L$  ( $R_L$  = effective external load of the four CD4066B bilateral switches). This provision avoids any permanent current flow or clamp action on the  $V_{DD}$  supply when power is applied or removed from the CD4066B.

In certain applications, the external load-resistor current can include both  $V_{DD}$  and signal-line components. To avoid drawing  $V_{DD}$  current when switch current flows into terminals 1, 4, 8, or 11, the voltage drop across the bidirectional switch must not exceed 0.8 V (calculated from  $r_{on}$  values shown).

No  $V_{DD}$  current will flow through  $R_L$  if the switch current flows into terminals 2, 3, 9, or 10.









#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CD4066BE	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4066BEE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4066BF	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
CD4066BF3A	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
CD4066BM	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BM96	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BM96E4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BME4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BMT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BMTE4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BNSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BNSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BPW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BPWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BPWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4066BPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
IM38510/05852BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



#### PACKAGE OPTION ADDENDUM

26-Sep-2005

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated